

Product Summary

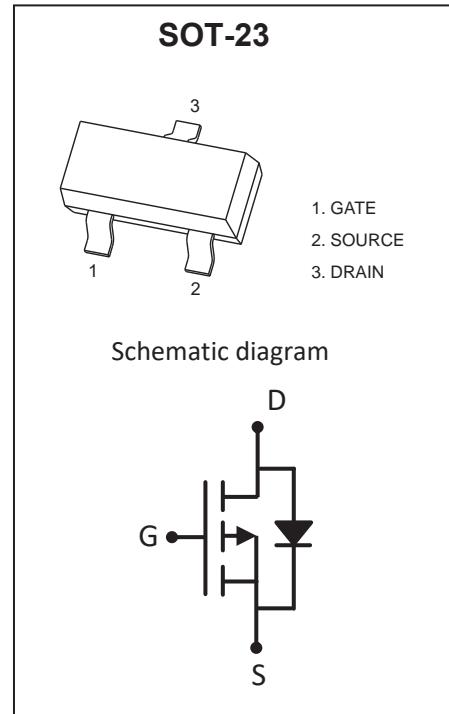
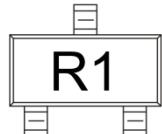
$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
-30V	43mΩ@-10V	-4.2A
	52mΩ@-4.5V	
	72mΩ@-2.5V	

Feature

- TrenchFET Power MOSFET
- Exceptional on-resistance and maximum DC current capability

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

MARKING:**ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain - Source Voltage	V_{DS}	-30	V
Gate - Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^{1,5}	I_D	-4.2	A
Pulsed Drain Current ²	I_{DM}	-17	A
Power Dissipation ^{4,5}	P_D	1.5	W
Thermal Resistance from Junction to Ambient ⁵	$R_{\theta JA}$	83.3	°C/W
Junction and Storage Temperature Range	T_J, T_{STG}	-55~ +150	°C

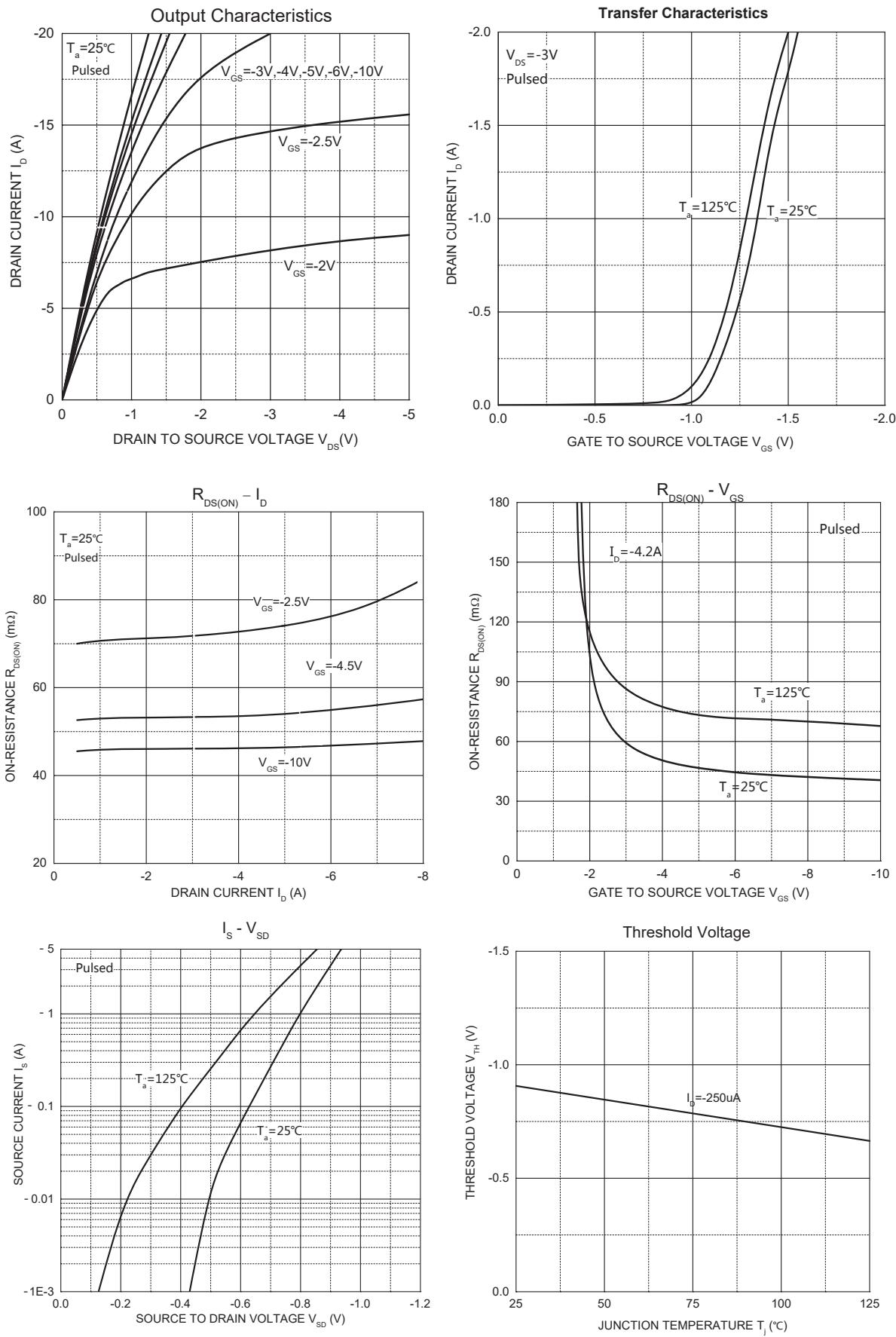
MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ\text{C}$ unless otherwise noted)

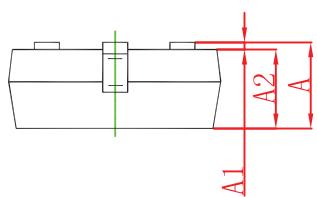
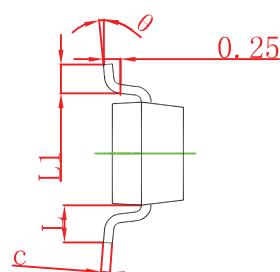
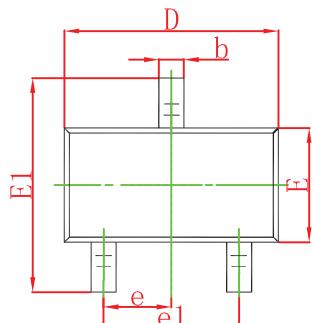
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = -250\mu\text{A}$	-30			V
Zero gate voltage drain current	I_{DSS}	$V_{\text{DS}} = -24\text{V}, V_{\text{GS}} = 0\text{V}$			-1	μA
Gate-body leakage current	I_{GSS}	$V_{\text{GS}} = \pm 12\text{V}, V_{\text{DS}} = 0\text{V}$			± 100	nA
Gate threshold voltage ³	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = -250\mu\text{A}$	-0.7	-0.9	-1.3	V
Drain-source on-resistance ³	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, I_D = -4.2\text{A}$		43	65	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_D = -4\text{A}$		52	75	
		$V_{\text{GS}} = -2.5\text{V}, I_D = -1\text{A}$		72	90	
Forward transconductance ³	g_{FS}	$V_{\text{DS}} = -5\text{V}, I_D = -4.2\text{A}$		10		S
Dynamic characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}} = -15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		954		pF
Output Capacitance	C_{oss}			115		
Reverse Transfer Capacitance	C_{rss}			77		
Switching characteristics						
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{GS}} = -10\text{V}, V_{\text{DS}} = -15\text{V}, R_L = 3.6\Omega, R_{\text{GEN}} = 6\Omega$			6.3	ns
Turn-on rise time	t_r				3.2	
Turn-off delay time	$t_{\text{d}(\text{off})}$				38.2	
Turn-off fall time	t_f				12	
Source-Drain Diode characteristics						
Diode forward current	I_s				-2	A
Diode pulsed forward current	I_{SM}				-15	A
Diode Forward voltage ³	V_{DS}	$V_{\text{GS}} = 0\text{V}, I_s = -4.2\text{A}$			-1.2	V

Notes:

- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width $\leq 10\mu\text{s}$, duty cycle $\leq 1\%$.
- 3.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- 4.The power dissipation P_D is limited by $T_{\text{J}(\text{MAX})} = 150^\circ\text{C}$.
- 5.Device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

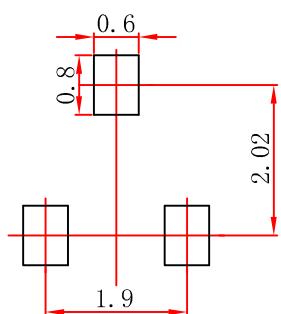
Typical Electrical and Thermal Characteristics





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.